

**Power Amplifier/Antenna Switch + Low Noise Down Conversion Mixer for PHS**

**Description**

The CXG1096FN is an MMIC consisting of the power amplifier, diversity antenna supported switch and low noise down conversion mixer.

This IC is designed using the Sony's GaAs J-FET process featuring a single positive power supply operation.

**Features**

- Operates at a single positive power supply:  $V_{DD} = 3V$
- Diversity antenna supported switch
- Small mold package: 26-pin HSOF

**<Power amplifier/antenna switch transmitter block >**

- Low current consumption:  $I_{DD} = 150mA$   
( $P_{OUT} = 20.2dBm, f = 1.9GHz$ )
- High power gain:  $G_p = 40dB$  Typ.  
( $P_{OUT} = 20.2dBm, f = 1.9GHz$ )

**<Antenna switch receiver block/  
low noise down conversion mixer>**

- Low current consumption:  $I_{DD} = 5.5mA$  Typ  
(When no signal)
- High conversion gain:  $G_c = 19.5dB$  Typ  
( $f = 1.9GHz$ )
- Low distortion: Input  $IP_3 = -12dBm$  Typ. ( $f = 1.9GHz$ )
- High image compression ratio:  $IMR = 40dBc$  Typ.  
( $f = 1.9GHz$ )
- High 1/2 IF compression ratio:  $1/2IFR = 47dBc$  Typ.  
( $f = 1.9GHz$ )

**Applications**

Japan digital cordless telephones (PHS)

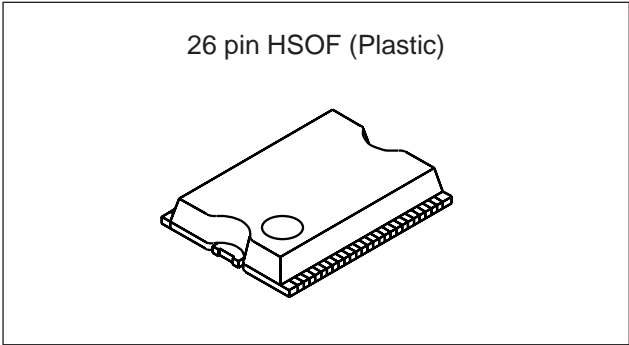
**Structure**

GaAs J-FET MMIC

**Note on Handling**

GaAs MMICs are ESD sensitive devices. Special handling precautions are required.

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**Absolute Maximum Ratings**

**<Power amplifier block>**

• Supply voltage	$V_{DD}$	6	V
• Voltage between gate and source	$V_{GSO}$	1.5	V
• Drain current	$I_{DD}$	550	mA
• Allowable power dissipation	$P_D$	3	W

**<Switch block>**

Control voltage	$V_{CTL}$	6	V
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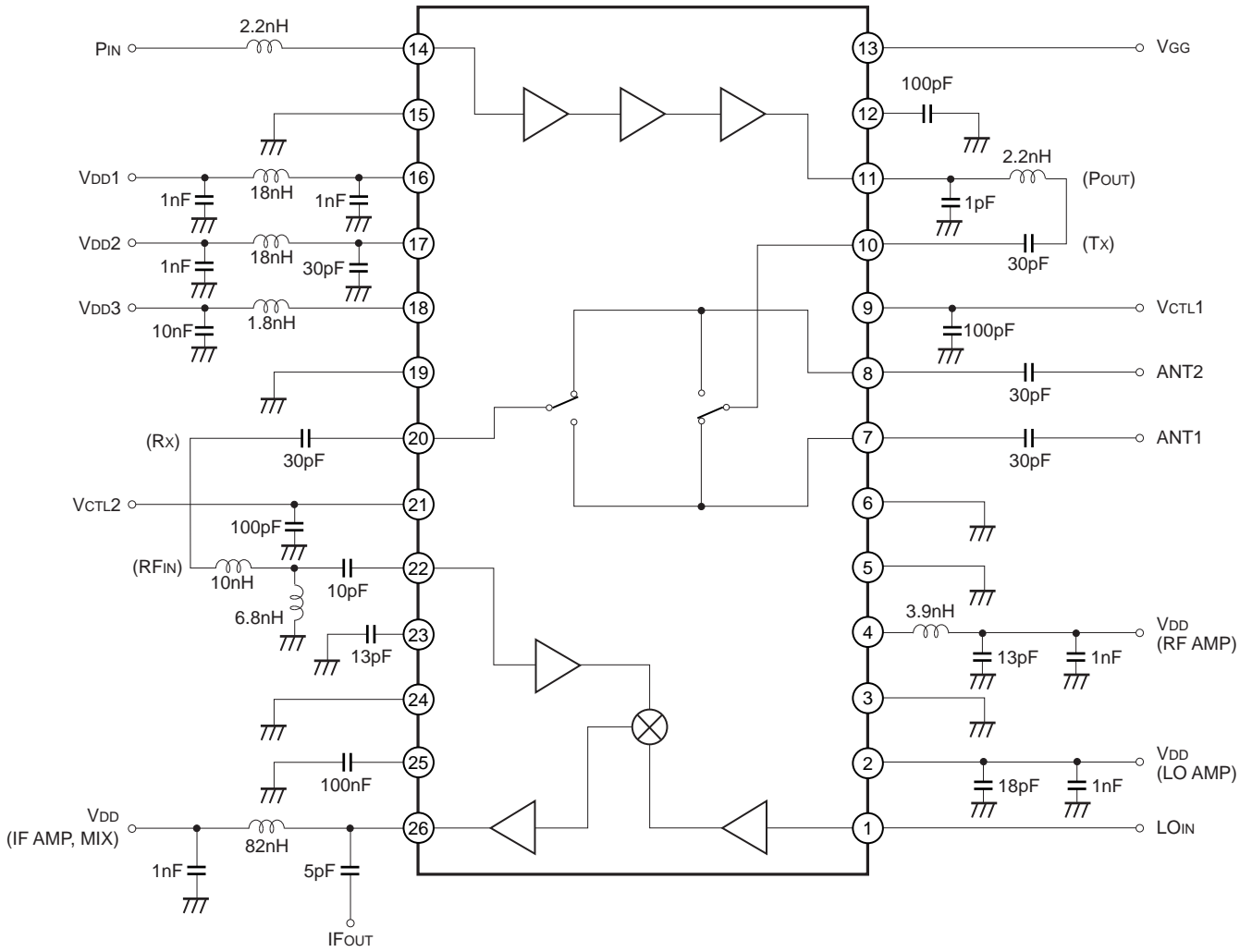
**<Front-end block>**

• Supply voltage	$V_{DD}$	6	V
• Input power	$P_{RF}$	+10	dBm

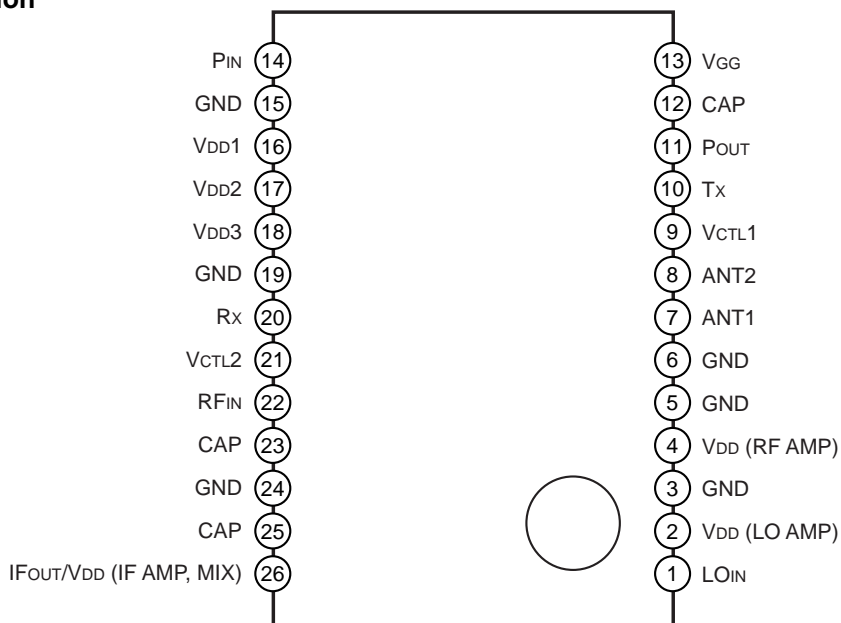
**<Common to each block>**

• Channel temperature	$T_{ch}$	150	°C
• Operating temperature	$T_{opr}$	-35 to +85	°C
• Storage temperature	$T_{stg}$	-65 to +150	°C

Block Diagram and External Circuit



Pin Configuration



**Electrical Characteristics**

These specifications are when the Sony's recommended evaluation board shown on page 6 is used.

**1. Power Amplifier Block + Antenna Switch Transmitter Block**

These specifications are common to the ANT1 transmission and ANT2 transmission.

Unless otherwise specified:  $V_{DD} = 3V$ ,  $I_{DD} = 150mA$ ,  $P_{OUT} = 20.2dBm$ ,  $f = 1.9GHz$

When ANT1 transmission:  $V_{CTL1} = 3V$ ,  $V_{CTL2} = 0V$

When ANT2 transmission:  $V_{CTL1} = 0V$ ,  $V_{CTL2} = 3V$  (Ta = 25°C)

Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Current consumption	$I_{DD}$			150		mA
Gate voltage adjustment value	$V_{GG}$		0.04		0.6	V
Output power	$P_{OUT}$	Measured with the ANT pin	20.2			dBm
Power gain	$G_P$		36	40		dB
Adjacent channel leak power ratio (600 ± 100kHz)	ACPR600kHz	Measured with the ANT pin		-63	-55	dBc
Adjacent channel leak power ratio (900 ± 100kHz)	ACPR900kHz	Measured with the ANT pin		-70	-60	dBc
Occupied bandwidth	OBW	Measured with the ANT pin		250	275	kHz
2nd-order harmonic level	—	Measured with the ANT pin			-25	dBc
3rd-order harmonic level	—	Measured with the ANT pin			-25	dBc

**2. Antenna Switch Receiver Block + Low Noise Down Conversion Mixer Block**

These specifications are common to the ANT1 reception and ANT2 reception.

Unless otherwise specified:  $V_{DD} = 3V$ ,  $RF1 = 1.90GHz/-35dBm$ ,  $LO = 1.66GHz/-15dBm$

When ANT1 reception:  $V_{CTL1} = 0V$ ,  $V_{CTL2} = 3V$

When ANT2 reception:  $V_{CTL1} = 3V$ ,  $V_{CTL2} = 0V$  (Ta = 25°C)

Item	Symbol	Measurement conditions	Min.	Typ.	Max.	Unit
Current consumption	$I_{DD}$	When no signal		5.5	7.5	mA
Conversion gain	$G_C$	When a small signal	17	19.5		dB
Noise figure	NF	When a small signal		4.4	5.5	dB
Input IP3	IIP3	*1	-17	-12		dBm
Image suppression ratio	IMR	$RF2 = 1.42GHz/-35dBm$	25	40		dBc
1/2 IF suppression ratio	1/2IFR	$RF2 = 1.78GHz/-35dBm$	41	47		dBc
2 × LO-IF suppression ratio	—	$RF2 = 3.08GHz/-35dBm$	39	45		dBc
2 × LO+IF suppression ratio	—	$RF2 = 3.56GHz/-35dBm$	34	65		dBc
LO to ANT leak	$P_{LK}$			-50	-40	dBm

\*1 Conversion from IM3 compression ratio during  $FR1 = 1.9000GHz/-35dBm$  and  $FR2 = 1.9006GHz/-35dBm$  input.

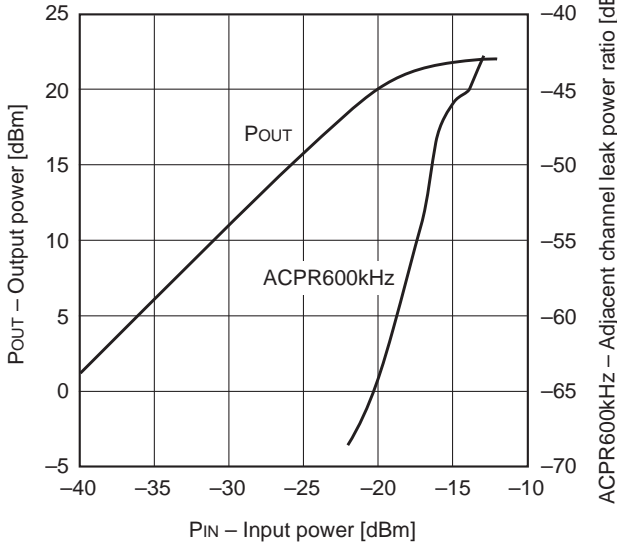
Example of Representative Characteristics

1. Power Amplifier + Antenna Switch Transmitter Block (f = 1.9GHz, Ta = 25°C)

**P<sub>OUT</sub>, ACPR600kHz vs. P<sub>IN</sub>**

V<sub>DD</sub> = 3V, V<sub>GG</sub> = const.,  
 I<sub>DD</sub> = 150mA (@P<sub>OUT</sub> = 20.2dBm),  
 P<sub>IN</sub> = var.  
 When ANT1 transmission: V<sub>CTL1</sub> = 3V, V<sub>CTL2</sub> = 0V  
 When ANT2 transmission: V<sub>CTL1</sub> = 0V, V<sub>CTL2</sub> = 3V

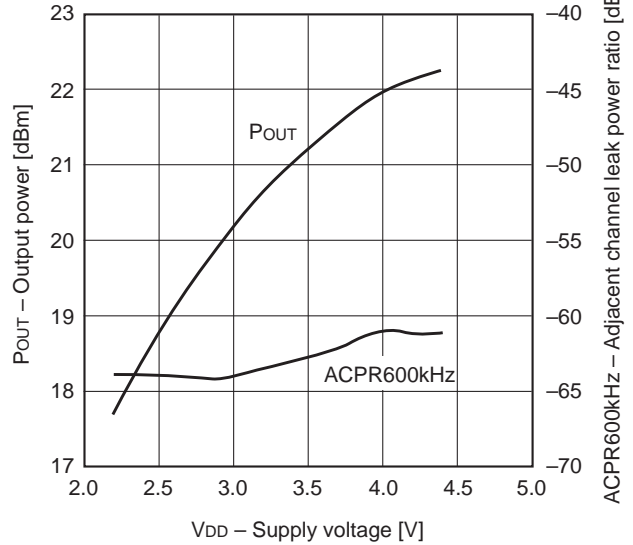
The data shown below is common to ANT1 and ANT2.



**P<sub>OUT</sub>, ACPR600kHz vs. V<sub>DD</sub>**

V<sub>DD</sub> = var., V<sub>GG</sub> = const.,  
 I<sub>DD</sub> = 150mA (@V<sub>DD</sub> = 3V, P<sub>OUT</sub> = 20.2dBm),  
 P<sub>IN</sub> = -19.7dBm  
 When ANT1 transmission: V<sub>CTL1</sub> = 3V, V<sub>CTL2</sub> = 0V  
 When ANT2 transmission: V<sub>CTL1</sub> = 0V, V<sub>CTL2</sub> = 3V

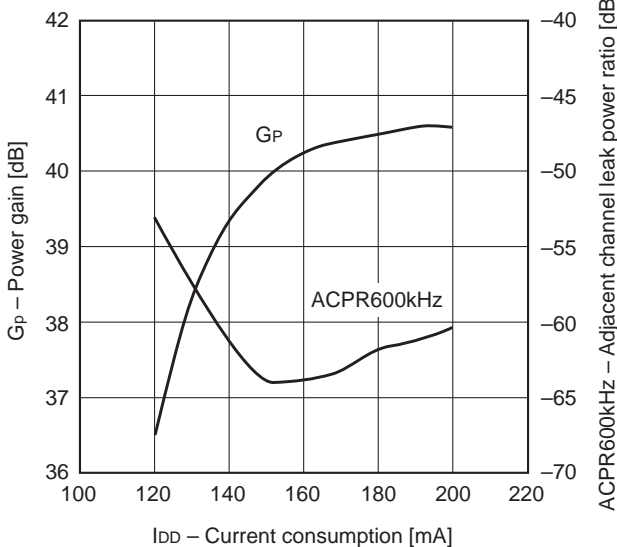
The data shown below is common to ANT1 and ANT2.



**G<sub>p</sub>, ACPR600kHz vs. I<sub>DD</sub>**

V<sub>DD</sub> = 3V, V<sub>GG</sub> = var., I<sub>DD</sub> = var., P<sub>IN</sub> = var.,  
 P<sub>OUT</sub> = 20.2dBm  
 When ANT1 transmission: V<sub>CTL1</sub> = 3V, V<sub>CTL2</sub> = 0V  
 When ANT2 transmission: V<sub>CTL1</sub> = 0V, V<sub>CTL2</sub> = 3V

The data shown below is common to ANT1 and ANT2.

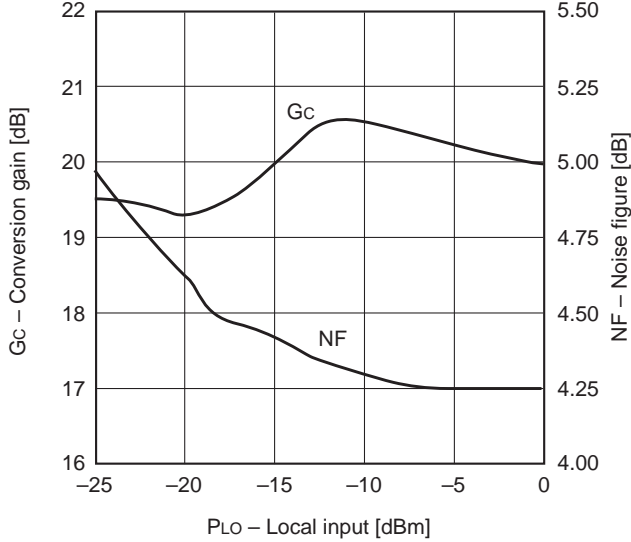


2. Antenna Switch Receiver Block + Low Noise Down Conversion Mixer (Ta = 25°C)

Gc, NF vs. PLO

VDD = 3V, RF1 = 1.90GHz/small signal,  
 LO = 1.66GHz  
 When ANT1 reception: VCTL1 = 0V, VCTL2 = 3V  
 When ANT2 reception: VCTL1 = 3V, VCTL2 = 0V

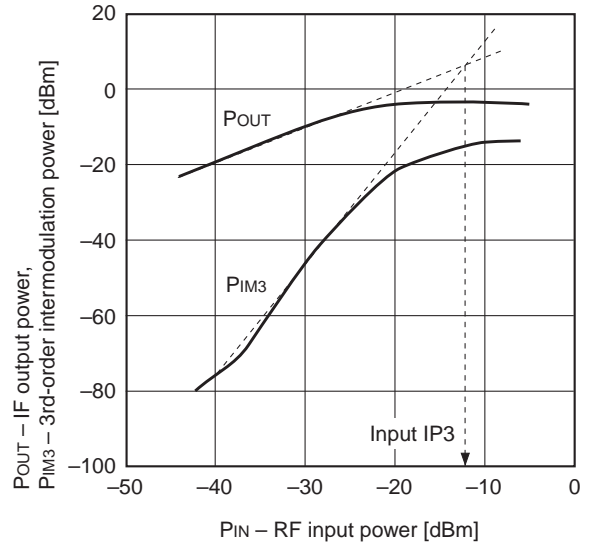
The data shown below is common to ANT1 and ANT2.



POUT, PIM3 vs. PIN

VDD = 3V, RF1 = 1.9000GHz, RF2 = 1.9006GHz,  
 LO = 1.66GHz/-15dBm  
 When ANT1 reception: VCTL1 = 0V, VCTL2 = 3V  
 When ANT2 reception: VCTL1 = 3V, VCTL2 = 0V

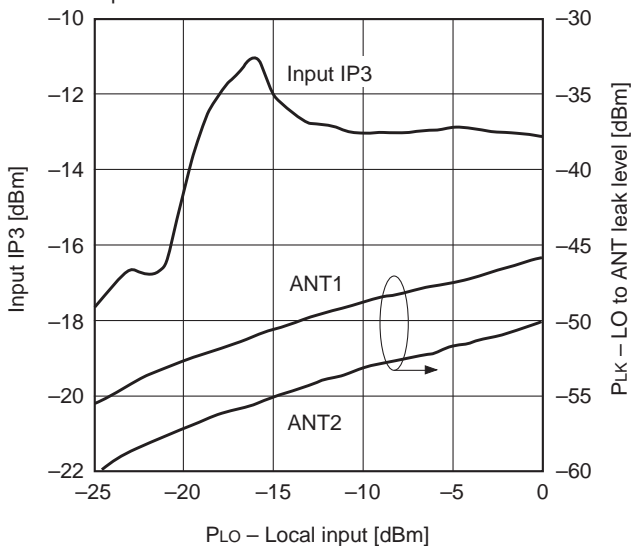
The data shown below is common to ANT1 and ANT2.



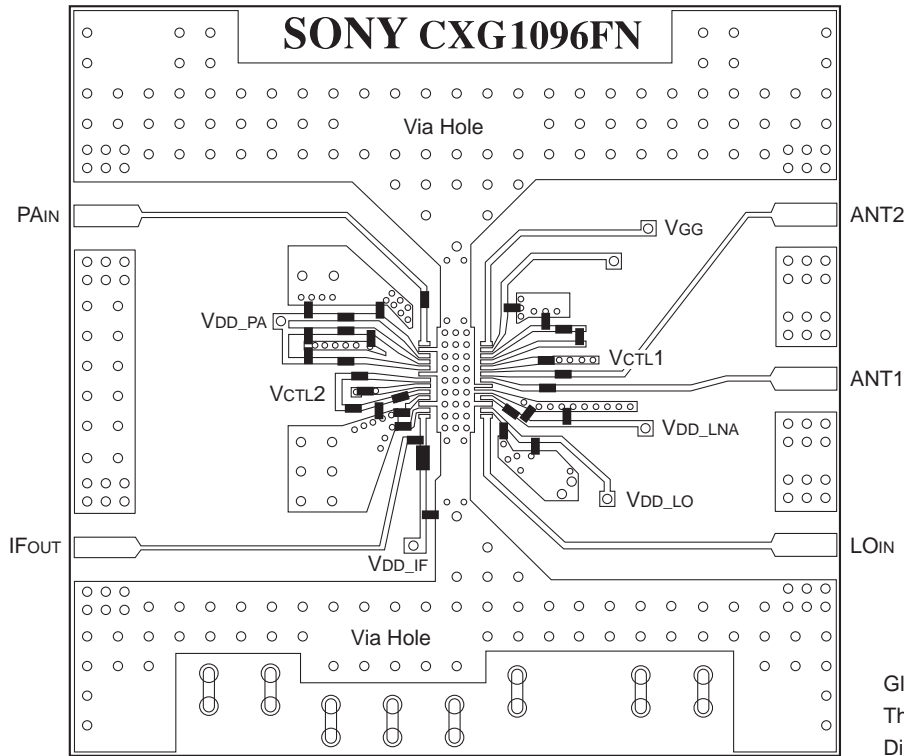
Input IP3, PLK vs. PLO

VDD = 3V, RF = 1.90GHz/-35dBm,  
 LO = 1.66GHz  
 When ANT1 reception: VCTL1 = 0V, VCTL2 = 3V  
 When ANT2 reception: VCTL1 = 3V, VCTL2 = 0V

Input IP3 is common to ANT1 and ANT2.

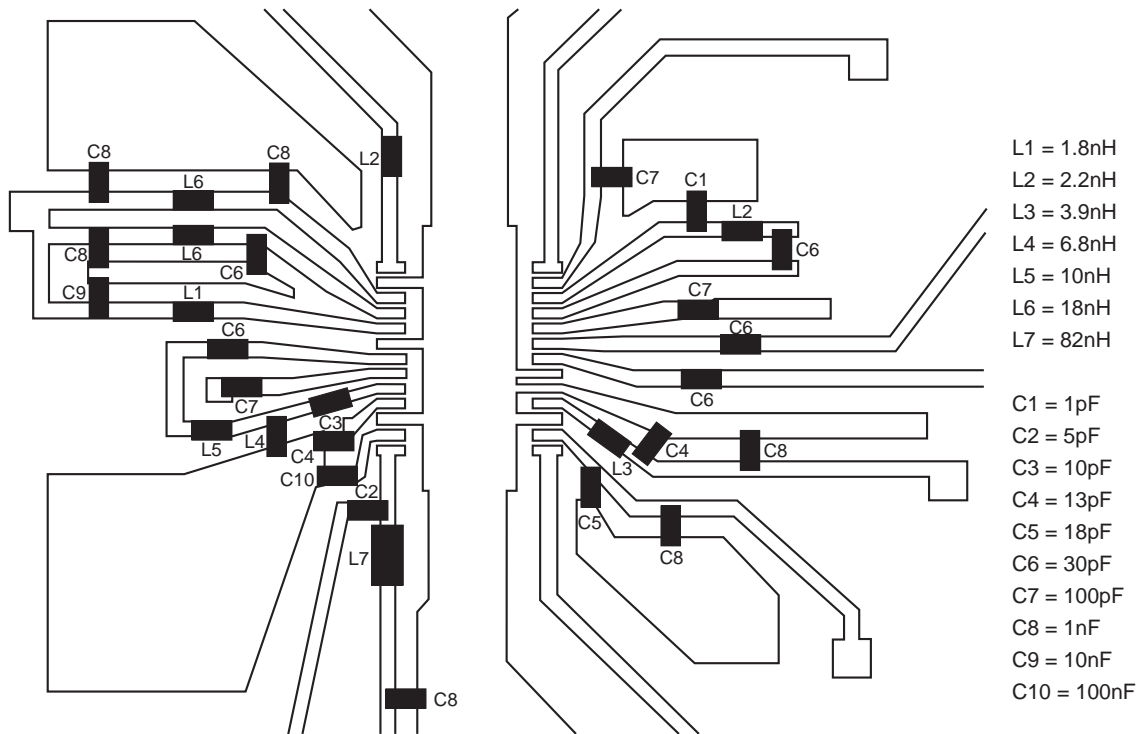


Recommended Evaluation Board



Glass fabric-base epoxy board (4 layers)  
 Thickness between layers 1 and 2: 0.2mm  
 Dimensions: 50mm × 50mm

Enlarged Diagram of External Circuit Block



- L1 = 1.8nH
- L2 = 2.2nH
- L3 = 3.9nH
- L4 = 6.8nH
- L5 = 10nH
- L6 = 18nH
- L7 = 82nH
- C1 = 1pF
- C2 = 5pF
- C3 = 10pF
- C4 = 13pF
- C5 = 18pF
- C6 = 30pF
- C7 = 100pF
- C8 = 1nF
- C9 = 10nF
- C10 = 100nF

